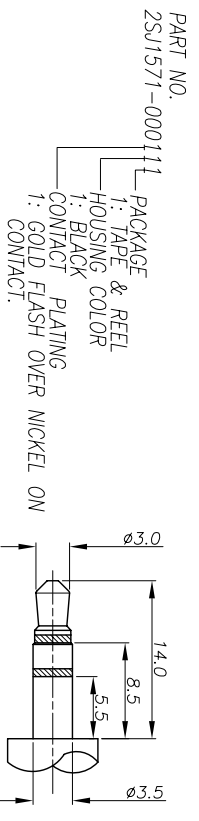


- SPECIFICATIONS:
1. HALOGEN FREE PRODUCT IDENTIFICATION LABEL ON PACKAGING:
 2. SOLDER HEAT RESISTANCE : 260°C 10 SECS.
 3. TO CONFORM TO THE SINGATRON HSF SPECIFICATION";
 4. SEE "2SJ1571 SERIES" SPECIFICATION
 5. PACKAGE : SEE " 2SJ1558 SERIES" PACKAGE



G	MYLAR	1	POLYIMIDE
F	MYLAR	1	POLYIMIDE
E	P CONTACT	1	BRONZE C5210
D	GND CONTACT	1	Be-Cu
C	T CONTACT	1	BRONZE C5210
B	R/D(A) CONTACT	2	BRONZE C5210
A	HOUSING	1	PA10T UL94V-0
NO	DESCRIPTION	QTY	MATERIAL
UNLESS OTHERWISE SPECIFIED TOLERANCES			
Singatron Enterprise Co., Ltd. 信亨企業股份有限公司			
TITLE : 03.5mm PHONE JACK			
DWN : 2010.02.10 PART NO. 2SJ1571-000111			
CHKD : 2010.02.10 SCALE: N/A UNIT: mm			
APVD : 2010.02.10 SIZE: A3 SHEET: 1 OF 1 REV: A			
CUSTOMER COPY			

REV	ECN NO OR DESCRIPTION	REVISED	DATE
A	PDR RELEASE	IVY-C	2010.02.10